

TRENCHSTOP™ 5 WR6 technology in enhanced creepage and clearance package offers improved reliability against package contamination

Features

- $V_{CE} = 650\text{ V}$
- $I_C = 40\text{ A}$
- Pin-to-pin creepage distance $> 4.8\text{ mm}$
- Pin-to-pin clearance distance $> 3.4\text{ mm}$
- Monolithic diode optimized for PFC and welding applications
- Stable temperature behavior
- Very low V_{CEsat} and low E_{off}
- Easy parallel switching capability based on positive temperature coefficient of V_{CEsat}
- Low temperature dependence of V_{CEsat} and E_{sw}
- Product spectrum and PSpice Models: <http://www.infineon.com/igbt/>

Potential applications

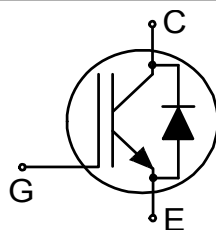
- PFC
- Welding
- ZCS applications

Product validation

- Qualified for industrial applications according to the relevant tests of JEDEC47/20/22



Description



Type	Package	Marking
IKWH40N65WR6	PG-TO247-3-STD-NN4.8	H40EWR6



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1 Package

Table 1 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Internal emitter inductance measured 5 mm (0.197 in.) from case	L_E			13		nH
Storage temperature	T_{stg}		-55		150	°C
Soldering temperature	T_{sold}	wave soldering 1.6 mm (0.063 in.) from case for 10 s			260	°C
Mounting torque	M	M3 screw, Maximum of mounting process: 3			0.6	Nm
Thermal resistance, junction-ambient	$R_{th(j-a)}$				40	K/W
IGBT thermal resistance, junction-case	$R_{th(j-c)}$				0.9	K/W
Diode thermal resistance, junction-case	$R_{th(j-c)}$				4.2	K/W

2 IGBT

Table 2 Maximum rated values

Parameter	Symbol	Note or test condition		Values	Unit
Collector-emitter voltage	V_{CE}	$T_{vj} \geq 25\text{ °C}$		650	V
DC collector current, limited by T_{vjmax}	I_C		$T_c = 25\text{ °C}$	70	A
			$T_c = 100\text{ °C}$	45	
Pulsed collector current, t_p limited by T_{vjmax}	I_{Cpulse}			120	A
Turn-off safe operating area		$V_{CE} \leq 650\text{ V}, T_{vj} \leq 175\text{ °C}$		120	A
Gate-emitter voltage	V_{GE}			± 20	V
Transient gate-emitter voltage	V_{GE}	$t_p \leq 10\text{ }\mu\text{s}, D < 0.01$		± 30	V
Power dissipation	P_{tot}		$T_c = 25\text{ °C}$	175	W
			$T_c = 100\text{ °C}$	78	

Table 3 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter breakdown voltage	V_{BRCES}	$I_C = 0.2\text{ mA}, V_{GE} = 0\text{ V}$	650			V

(table continues...)

Table 3 (continued) Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Collector-emitter saturation voltage	V_{CEsat}	$I_C = 40\text{ A}$, $V_{GE} = 15\text{ V}$	$T_{vj} = 25\text{ °C}$		1.55	1.85	V
			$T_{vj} = 175\text{ °C}$		1.8		
Gate-emitter threshold voltage	V_{GETh}	$I_C = 0.4\text{ mA}$, $V_{CE} = V_{GE}$		3.2	4	4.8	V
Zero gate-voltage collector current	I_{CES}	$V_{CE} = 650\text{ V}$, $V_{GE} = 0\text{ V}$	$T_{vj} = 25\text{ °C}$			40	μA
			$T_{vj} = 175\text{ °C}$		0.5		mA
Gate-emitter leakage current	I_{GES}	$V_{CE} = 0\text{ V}$, $V_{GE} = 20\text{ V}$				100	nA
Transconductance	g_{fs}	$I_C = 40\text{ A}$, $V_{CE} = 20\text{ V}$			89		S
Input capacitance	C_{ies}	$V_{CE} = 25\text{ V}$, $V_{GE} = 0\text{ V}$, $f = 100\text{ kHz}$			2890		pF
Output capacitance	C_{oes}	$V_{CE} = 25\text{ V}$, $V_{GE} = 0\text{ V}$, $f = 100\text{ kHz}$			28		pF
Reverse transfer capacitance	C_{res}	$V_{CE} = 25\text{ V}$, $V_{GE} = 0\text{ V}$, $f = 100\text{ kHz}$			11		pF
Gate charge	Q_G	$I_C = 40\text{ A}$, $V_{GE} = 15\text{ V}$, $V_{CC} = 520\text{ V}$			117		nC
Turn-on delay time	$t_{d(on)}$	$V_{CC} = 400\text{ V}$, $V_{GE} = 0/15\text{ V}$, $R_{G(on)} = 27\text{ }\Omega$, $R_{G(off)} = 27\text{ }\Omega$, $L_\sigma = 30\text{ nH}$, $C_\sigma = 26\text{ pF}$	$T_{vj} = 25\text{ °C}$, $I_C = 40\text{ A}$		37		ns
			$T_{vj} = 175\text{ °C}$, $I_C = 40\text{ A}$		34		
Rise time (inductive load)	t_r	$V_{CC} = 400\text{ V}$, $V_{GE} = 0/15\text{ V}$, $R_{G(on)} = 27\text{ }\Omega$, $R_{G(off)} = 27\text{ }\Omega$, $L_\sigma = 30\text{ nH}$, $C_\sigma = 26\text{ pF}$	$T_{vj} = 25\text{ °C}$, $I_C = 40\text{ A}$		24		ns
			$T_{vj} = 175\text{ °C}$, $I_C = 40\text{ A}$		25		
Turn-off delay time	$t_{d(off)}$	$V_{CC} = 400\text{ V}$, $V_{GE} = 0/15\text{ V}$, $R_{G(on)} = 27\text{ }\Omega$, $R_{G(off)} = 27\text{ }\Omega$, $L_\sigma = 30\text{ nH}$, $C_\sigma = 26\text{ pF}$	$T_{vj} = 25\text{ °C}$, $I_C = 40\text{ A}$		353		ns
			$T_{vj} = 175\text{ °C}$, $I_C = 40\text{ A}$		401		
Fall time (inductive load)	t_f	$V_{CC} = 400\text{ V}$, $V_{GE} = 0/15\text{ V}$, $R_{G(on)} = 27\text{ }\Omega$, $R_{G(off)} = 27\text{ }\Omega$, $L_\sigma = 30\text{ nH}$, $C_\sigma = 26\text{ pF}$	$T_{vj} = 25\text{ °C}$, $I_C = 40\text{ A}$		23		ns
			$T_{vj} = 175\text{ °C}$, $I_C = 40\text{ A}$		18		
Turn-on energy	E_{on}	$V_{CC} = 400\text{ V}$, $V_{GE} = 0/15\text{ V}$, $R_{G(on)} = 27\text{ }\Omega$, $R_{G(off)} = 27\text{ }\Omega$, $L_\sigma = 30\text{ nH}$, $C_\sigma = 26\text{ pF}$	$T_{vj} = 25\text{ °C}$, $I_C = 40\text{ A}$		1.09		mJ
			$T_{vj} = 175\text{ °C}$, $I_C = 40\text{ A}$		1.23		

(table continues...)

Table 3 (continued) Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Turn-off energy	E_{off}	$V_{CC} = 400\text{ V}$, $V_{GE} = 0/15\text{ V}$, $R_{G(on)} = 27\ \Omega$, $R_{G(off)} = 27\ \Omega$, $L_{\sigma} = 30\text{ nH}$, $C_{\sigma} = 26\text{ pF}$	$T_{vj} = 25\text{ }^{\circ}\text{C}$, $I_C = 40\text{ A}$	0.57		mJ
			$T_{vj} = 175\text{ }^{\circ}\text{C}$, $I_C = 40\text{ A}$	0.89		
Total switching energy	E_{ts}	$V_{CC} = 400\text{ V}$, $V_{GE} = 0/15\text{ V}$, $R_{G(on)} = 27\ \Omega$, $R_{G(off)} = 27\ \Omega$, $L_{\sigma} = 30\text{ nH}$, $C_{\sigma} = 26\text{ pF}$	$T_{vj} = 25\text{ }^{\circ}\text{C}$, $I_C = 40\text{ A}$	1.66		mJ
			$T_{vj} = 175\text{ }^{\circ}\text{C}$, $I_C = 40\text{ A}$	2.12		
Operating junction temperature	T_{vj}		-40		175	$^{\circ}\text{C}$

Note: Electrical Characteristic, at $T_{vj} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified.

3 Diode

Table 4 Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit
Repetitive peak reverse voltage	V_{RRM}	$T_{vj} \geq 25\text{ }^{\circ}\text{C}$	650	V
Diode forward current, limited by T_{vjmax}	I_F	$T_C = 25\text{ }^{\circ}\text{C}$	20	A
		$T_C = 100\text{ }^{\circ}\text{C}$	11	
Diode pulsed current, t_p limited by T_{vjmax}	I_{Fpulse}		40	A

Table 5 Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Diode forward voltage	V_F	$I_F = 10\text{ A}$	$T_{vj} = 25\text{ }^{\circ}\text{C}$	1.3	1.6	V
			$T_{vj} = 175\text{ }^{\circ}\text{C}$	1.3		
Diode reverse recovery time	t_{rr}	$V_R = 400\text{ V}$	$T_{vj} = 25\text{ }^{\circ}\text{C}$, $I_F = 20\text{ A}$, $-di_F/dt = 1460\text{ A}/\mu\text{s}$	79		ns
			$T_{vj} = 175\text{ }^{\circ}\text{C}$, $I_F = 20\text{ A}$, $-di_F/dt = 1350\text{ A}/\mu\text{s}$	104		

(table continues...)

Table 5 (continued) Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Diode reverse recovery charge	Q_{rr}	$V_R = 400 \text{ V}$	$T_{vj} = 25 \text{ °C}$, $I_F = 20 \text{ A}$, $-di_F/dt = 1460 \text{ A/}\mu\text{s}$		1.4		μC
			$T_{vj} = 175 \text{ °C}$, $I_F = 20 \text{ A}$, $-di_F/dt = 1350 \text{ A/}\mu\text{s}$		2.5		
Diode peak reverse recovery current	I_{rrm}	$V_R = 400 \text{ V}$	$T_{vj} = 25 \text{ °C}$, $I_F = 20 \text{ A}$, $-di_F/dt = 1460 \text{ A/}\mu\text{s}$		24.7		A
			$T_{vj} = 175 \text{ °C}$, $I_F = 20 \text{ A}$, $-di_F/dt = 1350 \text{ A/}\mu\text{s}$		38.3		
Diode peak rate of fall of reverse recovery current	di_{rr}/dt	$V_R = 400 \text{ V}$	$T_{vj} = 25 \text{ °C}$, $I_F = 20 \text{ A}$, $-di_F/dt = 1460 \text{ A/}\mu\text{s}$		383		A/ μs
			$T_{vj} = 175 \text{ °C}$, $I_F = 20 \text{ A}$, $-di_F/dt = 1350 \text{ A/}\mu\text{s}$		821		
Operating junction temperature	T_{vj}			-40		175	°C

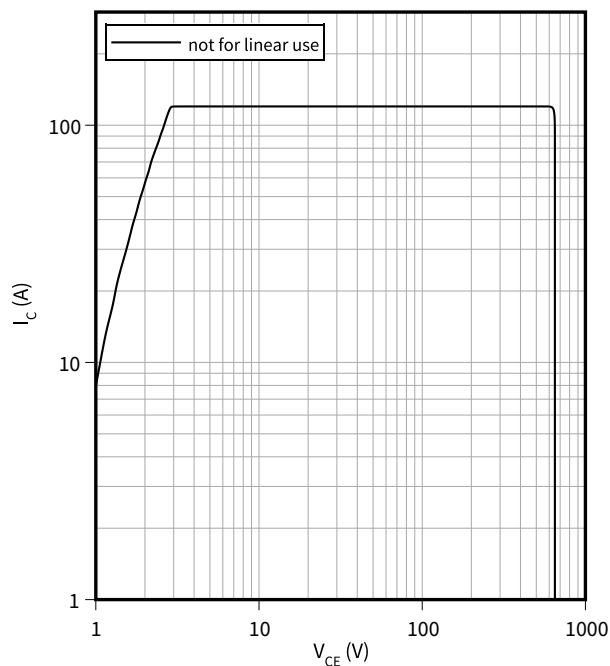
Note: For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

4 Characteristics diagrams

Reverse bias safe operating area

$$I_C = f(V_{CE})$$

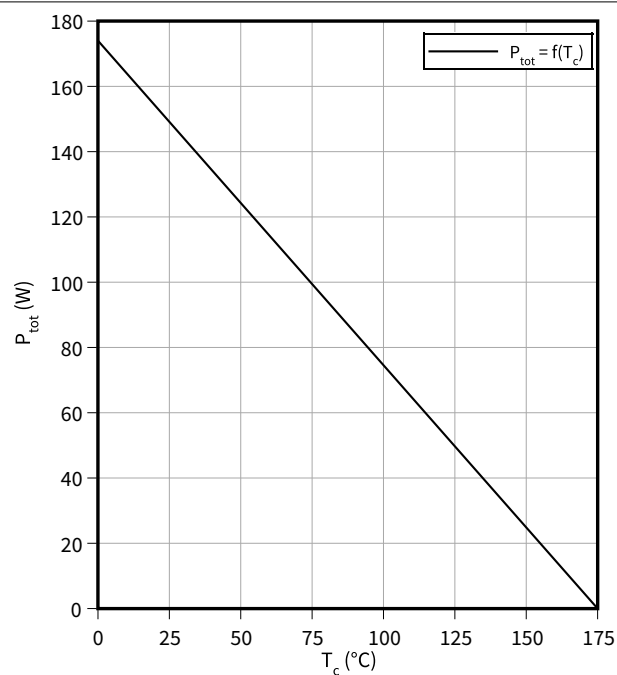
$$T_{vj} \leq 175\text{ °C}, T_C = 25\text{ °C}, V_{GE} = 15\text{ V}$$



Power dissipation as a function of case temperature

$$P_{tot} = f(T_C)$$

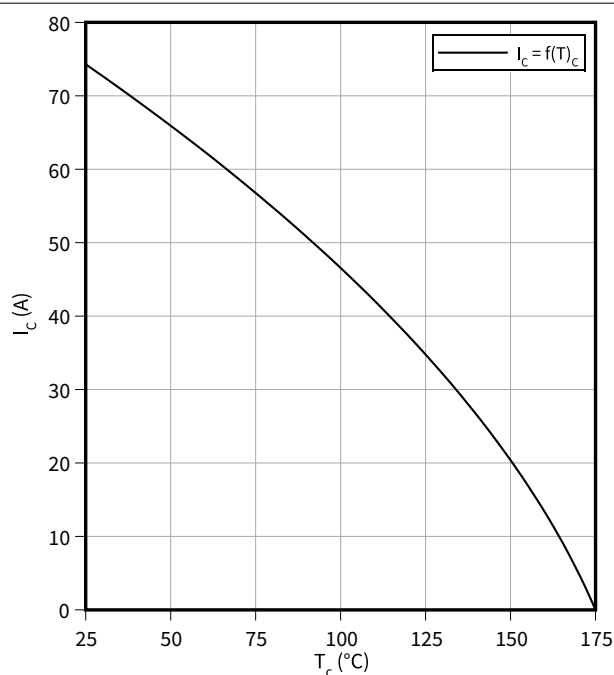
$$T_{vj} \leq 175\text{ °C}$$



Collector current as a function of case temperature

$$I_C = f(T_C)$$

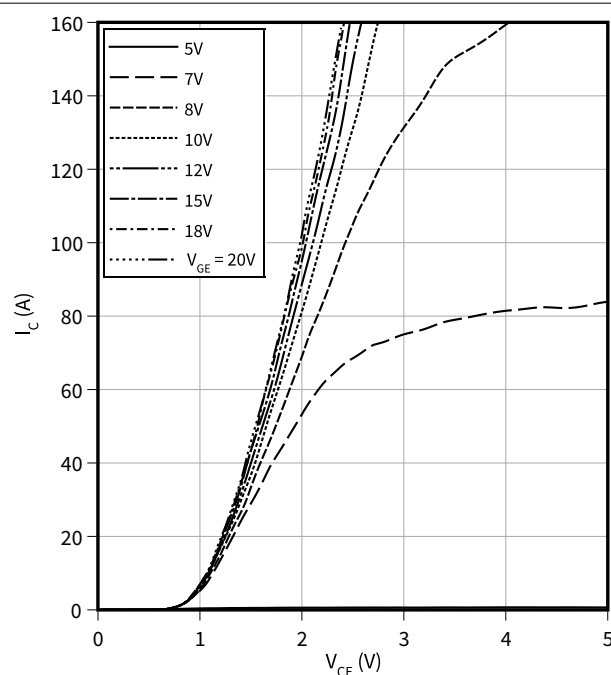
$$T_{vj} \leq 175\text{ °C}, V_{GE} \geq 15\text{ V}$$



Typical output characteristic

$$I_C = f(V_{CE})$$

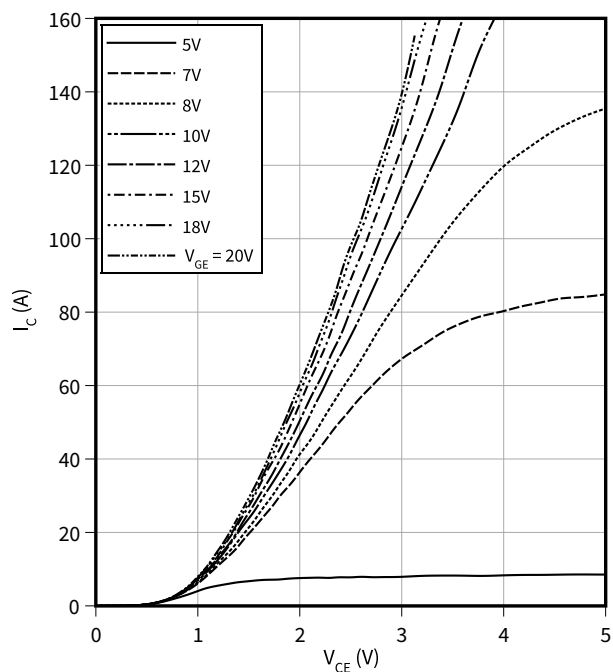
$$T_{vj} = 25\text{ °C}$$



Typical output characteristic

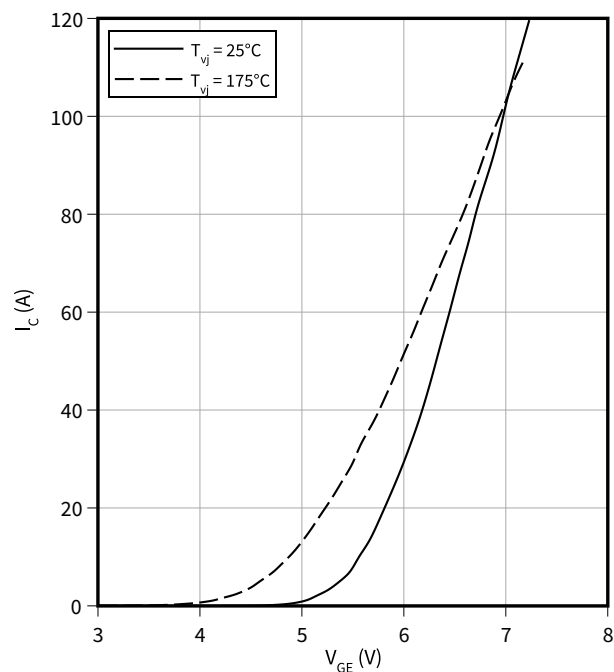
$$I_C = f(V_{CE})$$

$$T_{vj} = 175\text{ °C}$$


Typical transfer characteristic

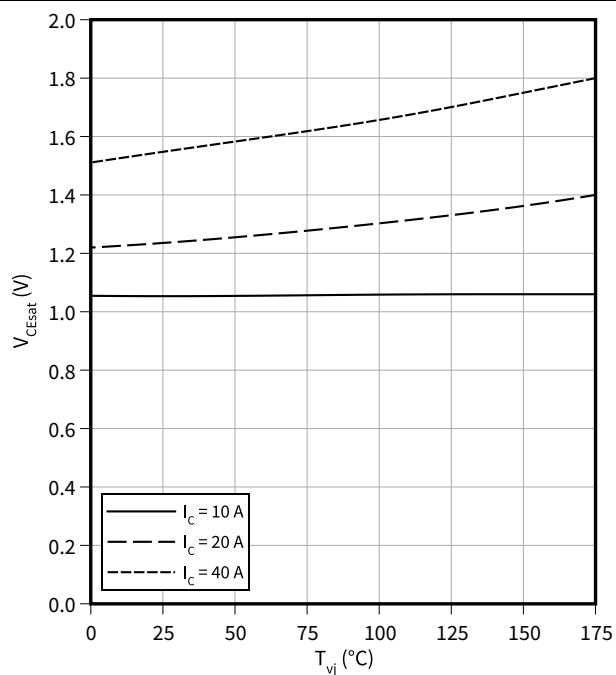
$$I_C = f(V_{GE})$$

$$V_{CE} = 20\text{ V}$$


Typical collector-emitter saturation voltage as a function of junction temperature

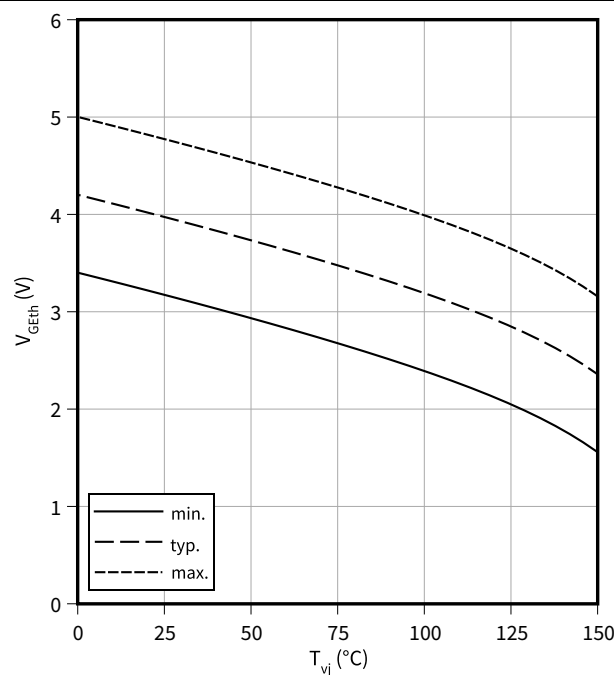
$$V_{CEsat} = f(T_{vj})$$

$$V_{GE} = 15\text{ V}$$


Gate-emitter threshold voltage as a function of junction temperature

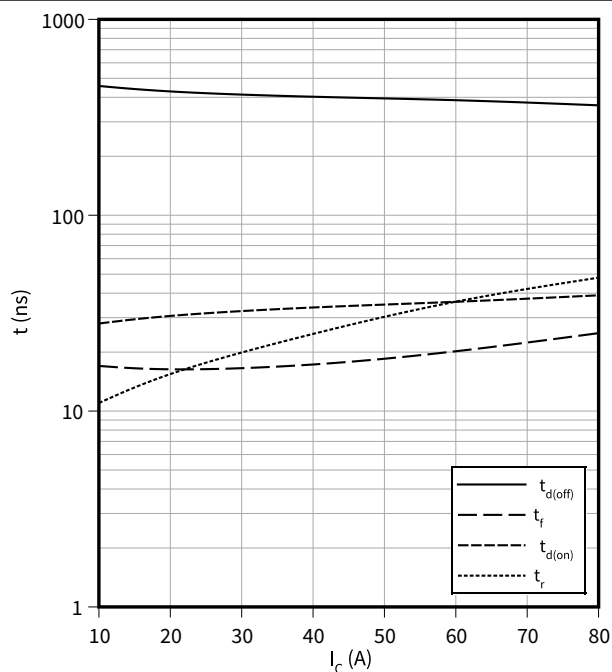
$$V_{GETh} = f(T_{vj})$$

$$I_C = 0.4\text{ mA}$$



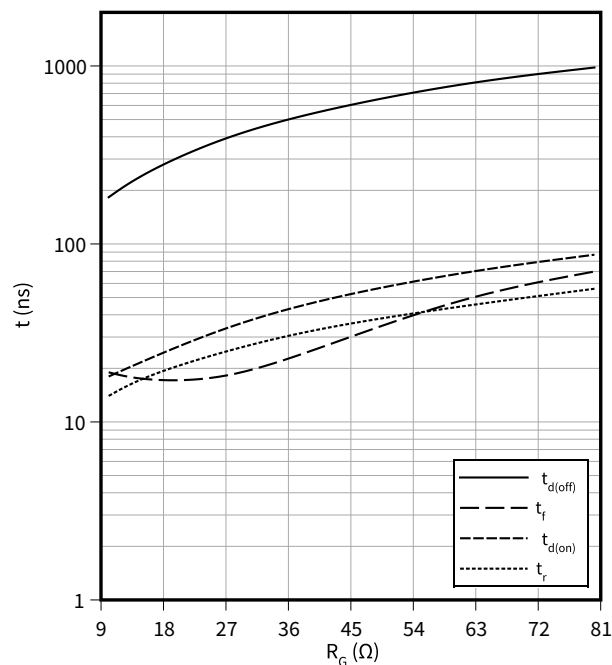
Typical switching times as a function of collector current

$$t = f(I_C)$$

 $V_{CC} = 400 \text{ V}, T_{vj} = 175 \text{ }^{\circ}\text{C}, V_{GE} = 0/15 \text{ V}, R_G = 27 \text{ } \Omega$


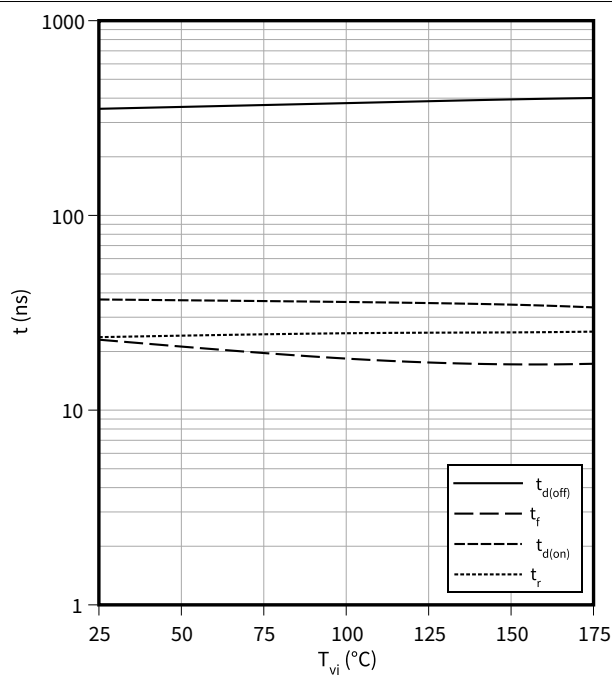
Typical switching times as a function of gate resistor

$$t = f(R_G)$$

 $I_C = 40 \text{ A}, V_{CC} = 400 \text{ V}, T_{vj} = 175 \text{ }^{\circ}\text{C}, V_{GE} = 0/15 \text{ V}$


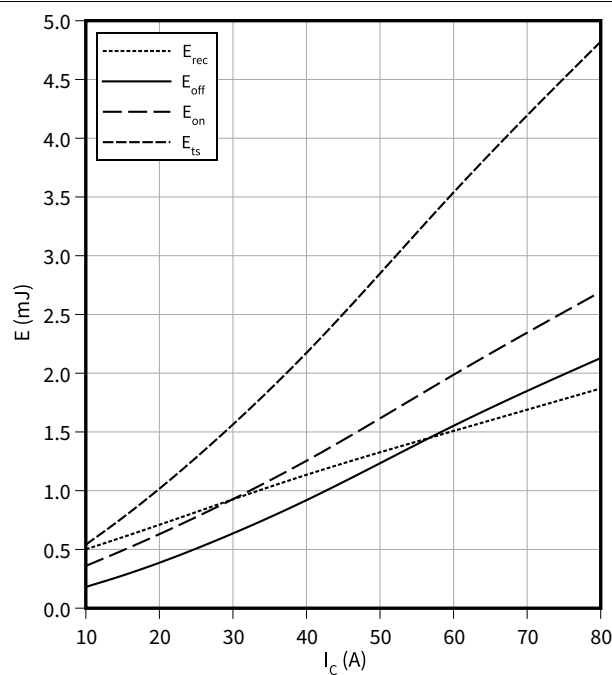
Typical switching times as a function of junction temperature

$$t = f(T_{vj})$$

 $I_C = 40 \text{ A}, V_{CC} = 400 \text{ V}, V_{GE} = 0/15 \text{ V}, R_G = 27 \text{ } \Omega$


Typical switching energy losses as a function of collector current

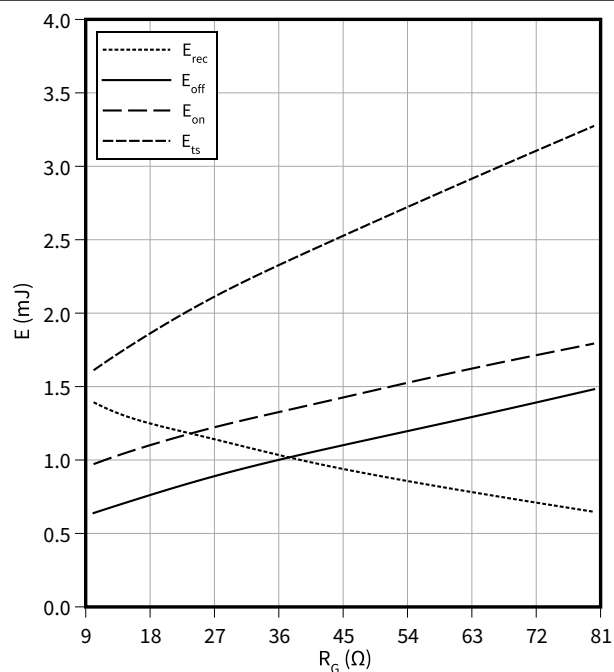
$$E = f(I_C)$$

 $V_{CC} = 400 \text{ V}, T_{vj} = 175 \text{ }^{\circ}\text{C}, V_{GE} = 0/15 \text{ V}, R_G = 27 \text{ } \Omega$


Typical switching energy losses as a function of gate resistor

$$E = f(R_G)$$

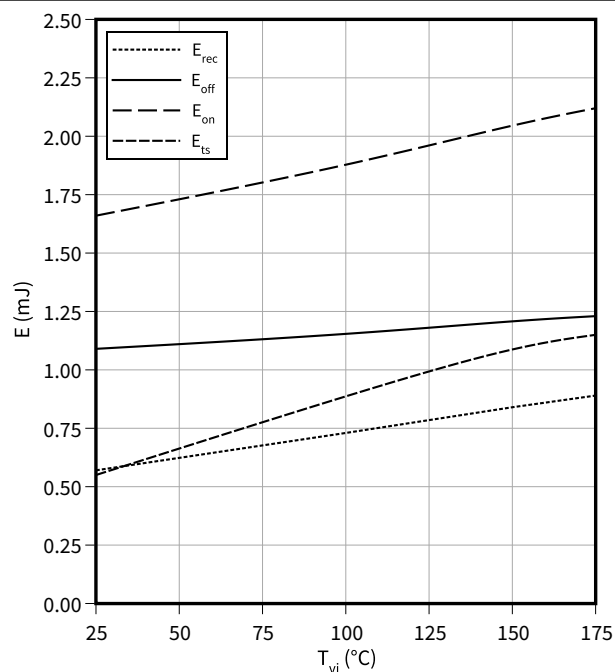
$I_C = 40 \text{ A}$, $V_{CC} = 400 \text{ V}$, $T_{vj} = 175 \text{ °C}$, $V_{GE} = 0/15 \text{ V}$



Typical switching energy losses as a function of junction temperature

$$E = f(T_{vj})$$

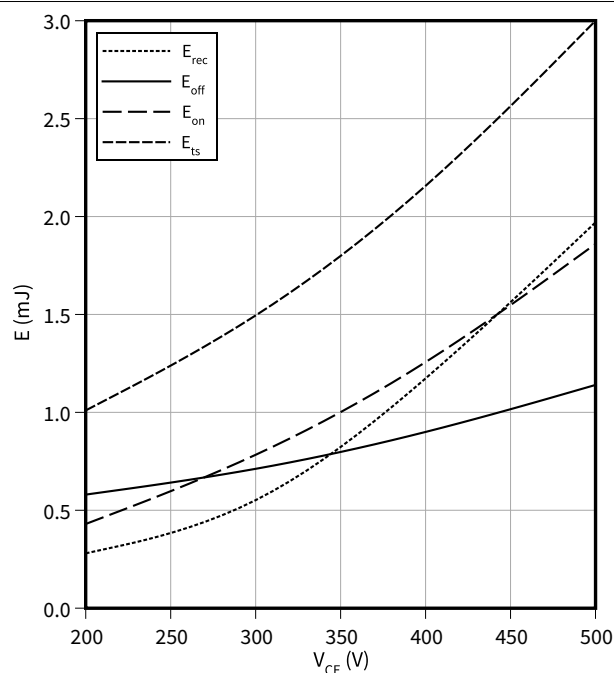
$I_C = 40 \text{ A}$, $V_{CC} = 400 \text{ V}$, $V_{GE} = 0/15 \text{ V}$, $R_G = 27 \text{ }\Omega$



Typical switching energy losses as a function of collector emitter voltage

$$E = f(V_{CE})$$

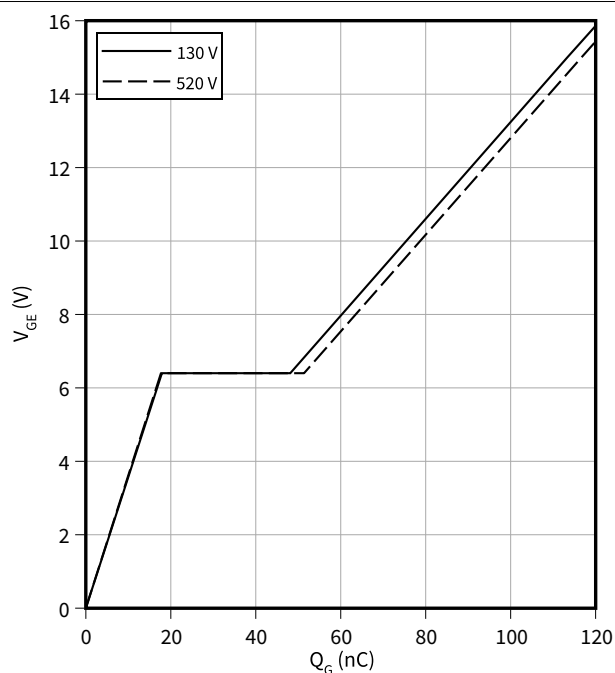
$I_C = 40 \text{ A}$, $T_{vj} = 175 \text{ °C}$, $V_{GE} = 0/15 \text{ V}$, $R_G = 27 \text{ }\Omega$



Typical gate charge

$$V_{GE} = f(Q_G)$$

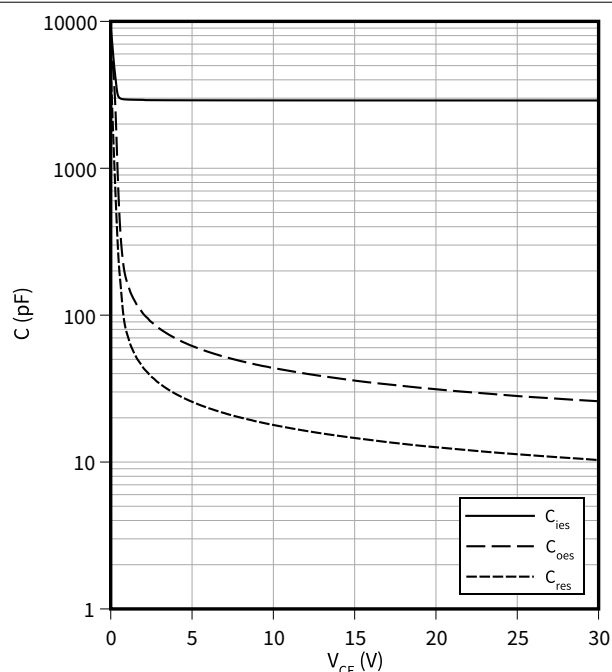
$I_C = 40 \text{ A}$



Typical capacitance as a function of collector-emitter voltage

$$C = f(V_{CE})$$

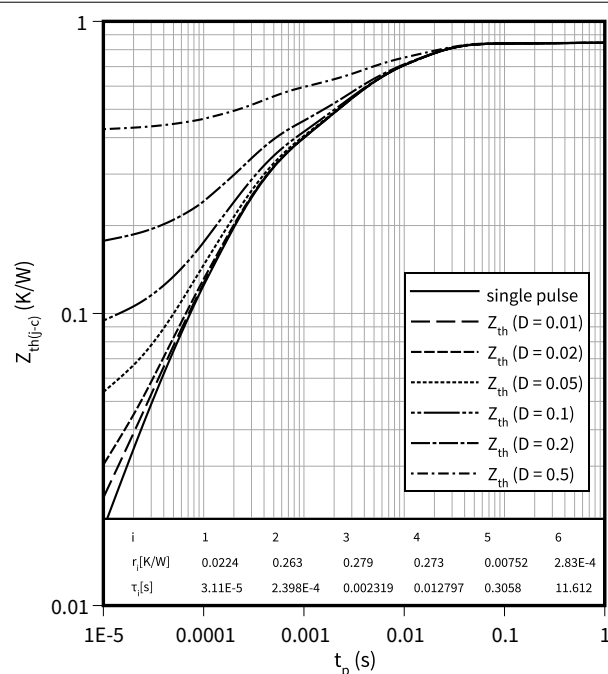
$$f = 100 \text{ kHz}, V_{GE} = 0 \text{ V}$$



IGBT transient thermal impedance as a function of pulse width

$$Z_{th(j-c)} = f(t_p)$$

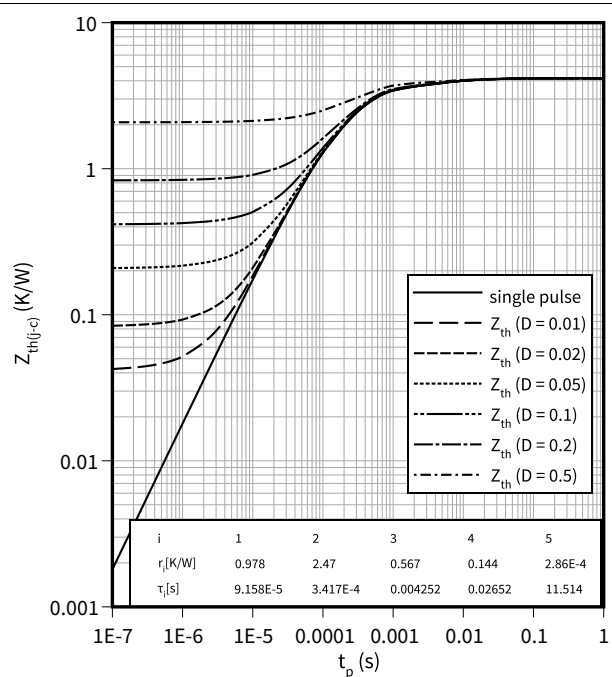
$$D = t_p/T$$



Diode transient thermal impedance as a function of pulse width

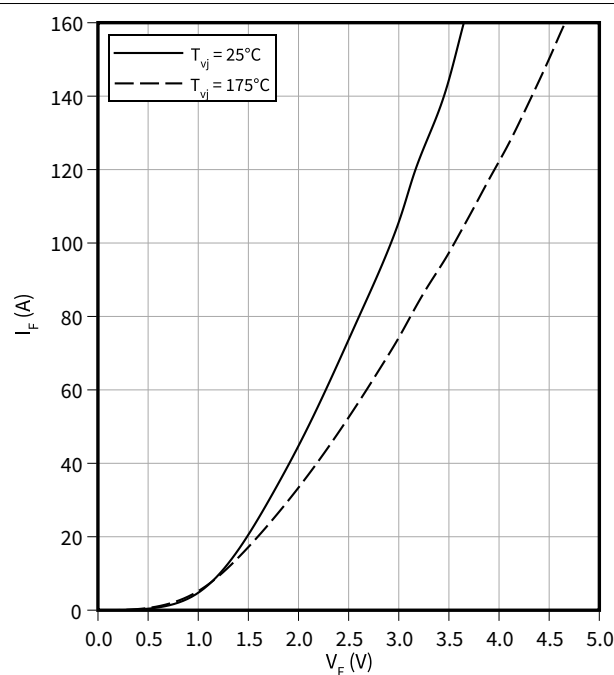
$$Z_{th(j-c)} = f(t_p)$$

$$D = t_p/T$$



Typical diode forward current as a function of forward voltage

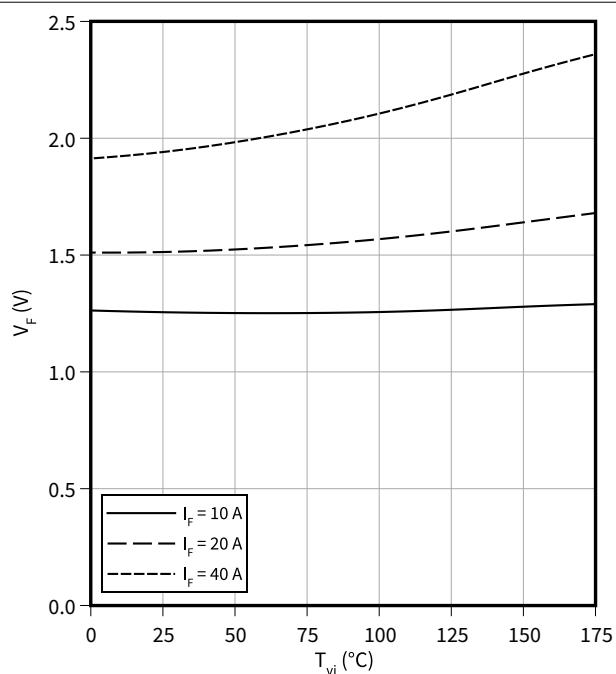
$$I_F = f(V_F)$$



4 Characteristics diagrams

Typical diode forward voltage as a function of junction temperature

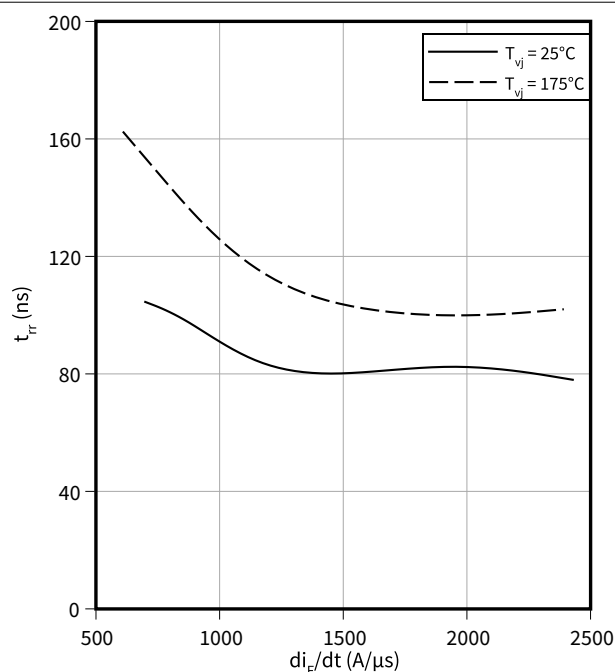
$$V_F = f(T_{vj})$$



Typical reverse recovery time as a function of diode current slope

$$t_{rr} = f(di_F/dt)$$

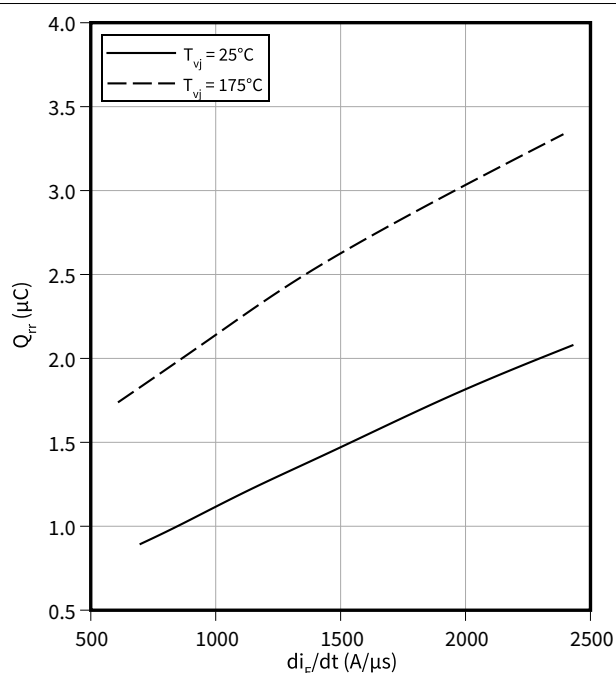
$$V_R = 400 \text{ V}, I_F = 20 \text{ A}$$



Typical reverse recovery charge as a function of diode current slope

$$Q_{rr} = f(di_F/dt)$$

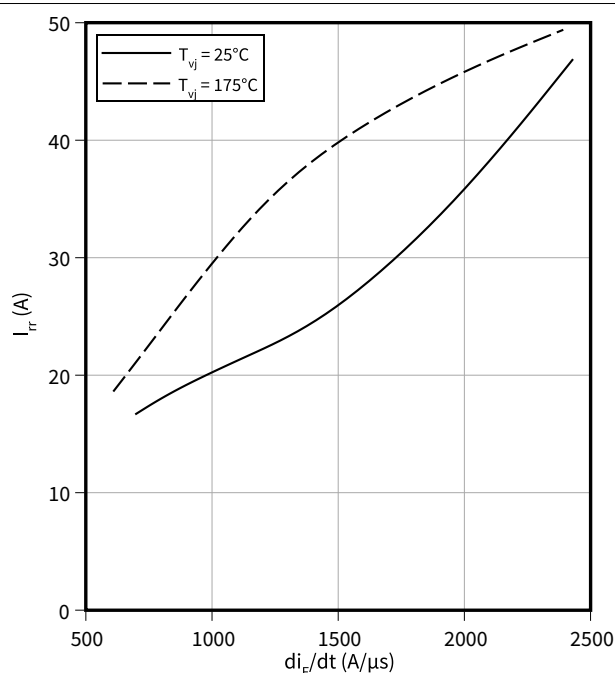
$$I_F = 20 \text{ A}, V_R = 400 \text{ V}$$



Typical reverse recovery current as a function of diode current slope

$$I_{rrm} = f(di_F/dt)$$

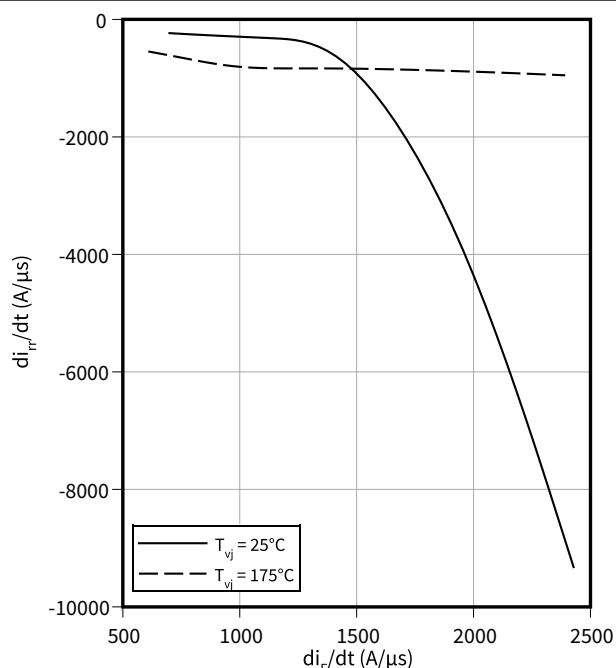
$$I_F = 20 \text{ A}, V_R = 400 \text{ V}$$



Typical diode peak rate of fall of reverse recovery current as a function of diode current slope

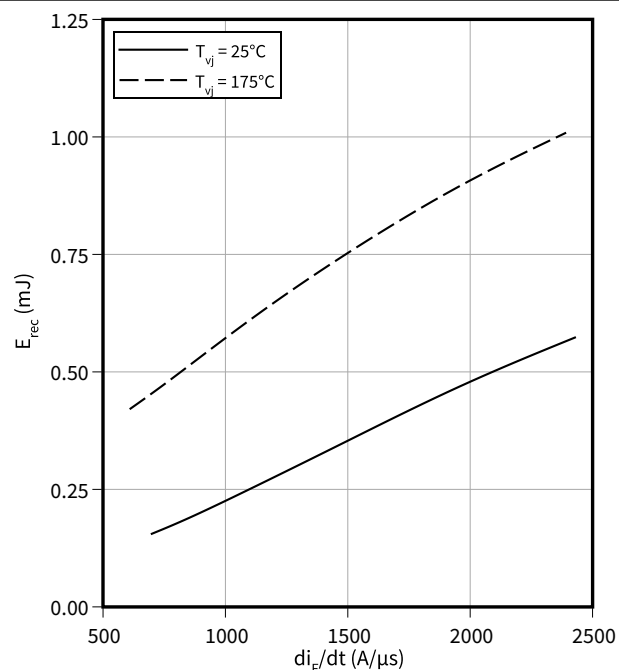
$$di_{rr}/dt = f(di_F/dt)$$

$$V_R = 400 \text{ V}, I_F = 20 \text{ A}$$


Typical reverse energy losses as a function of diode current slope

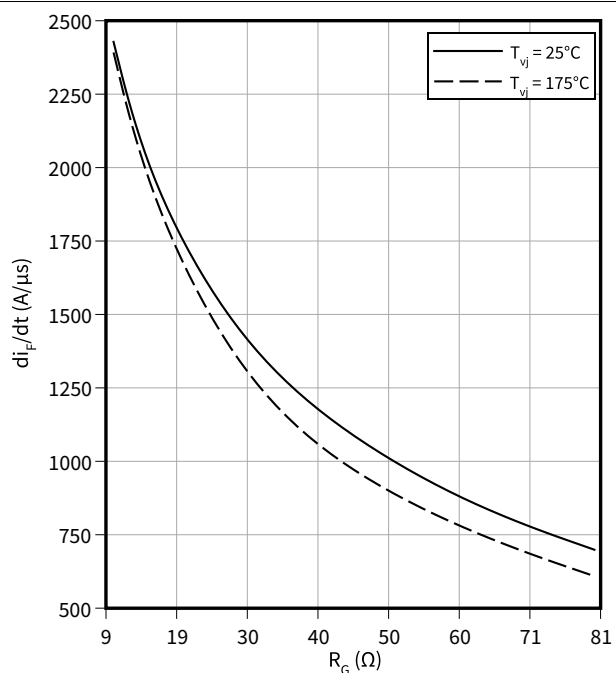
$$E_{rec} = f(di_F/dt)$$

$$V_R = 400 \text{ V}, I_F = 20 \text{ A}$$


Typical diode current slope as a function of gate resistor

$$di_F/dt = f(R_G)$$

$$V_R = 400 \text{ V}, I_F = 20 \text{ A}$$



5

Package outlines

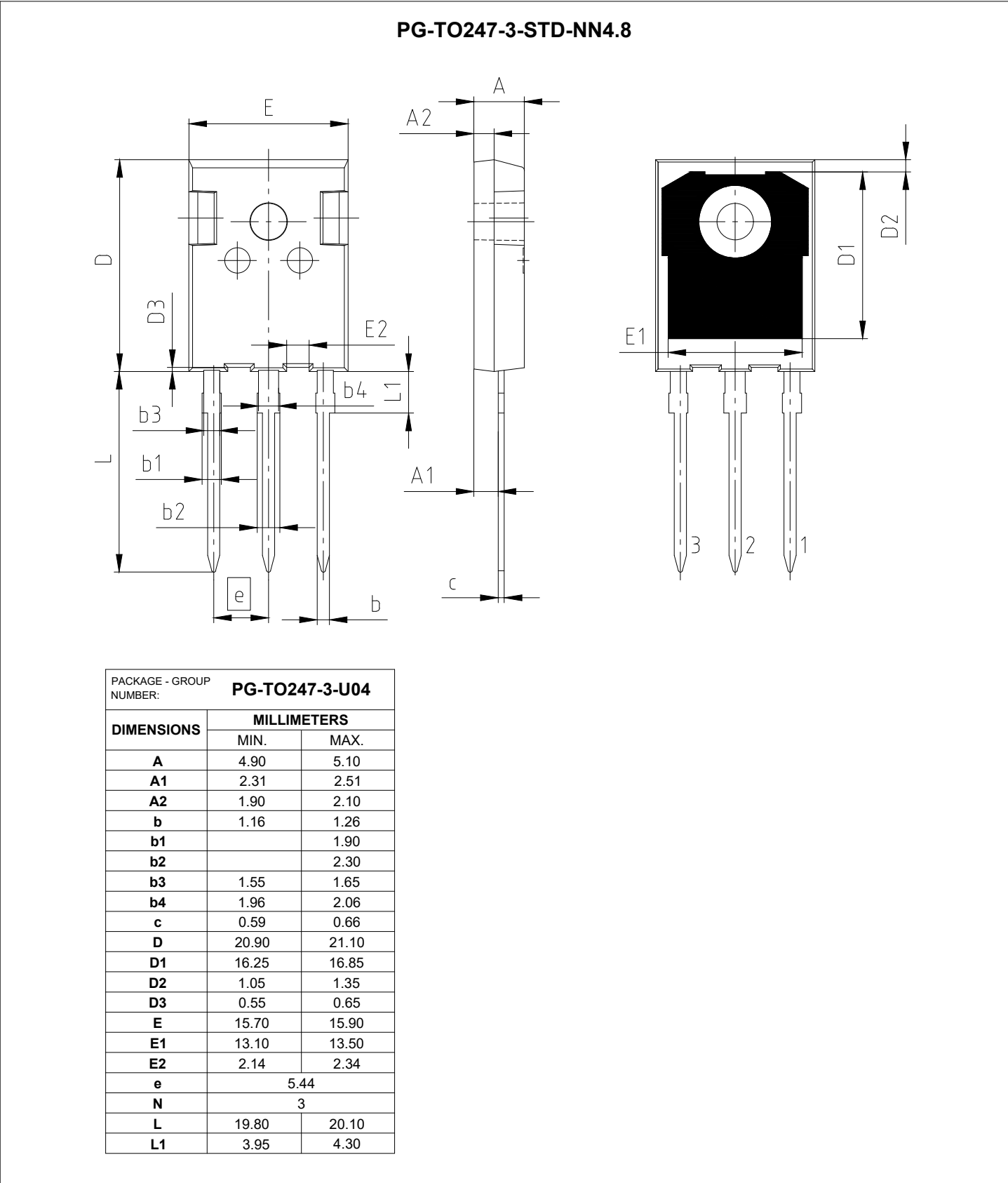


Figure 1

6 Testing conditions

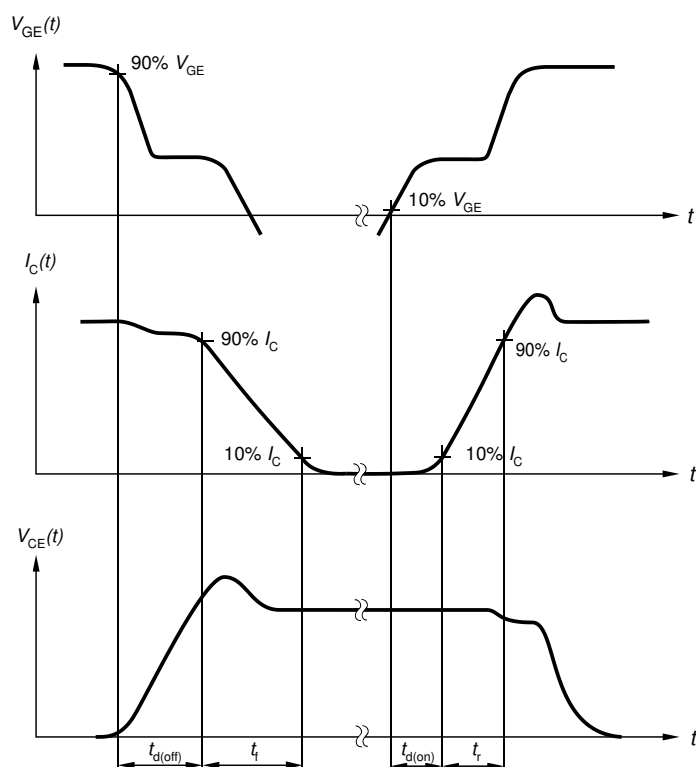


Figure A. Definition of switching times

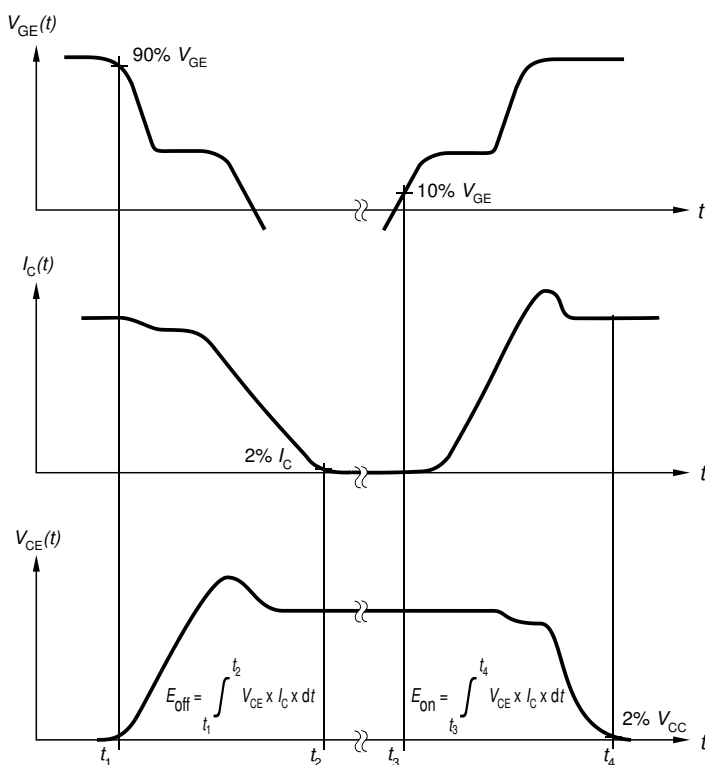


Figure B. Definition of switching losses

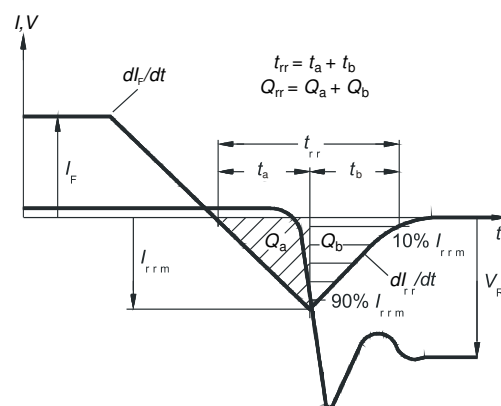


Figure C. Definition of diode switching characteristics

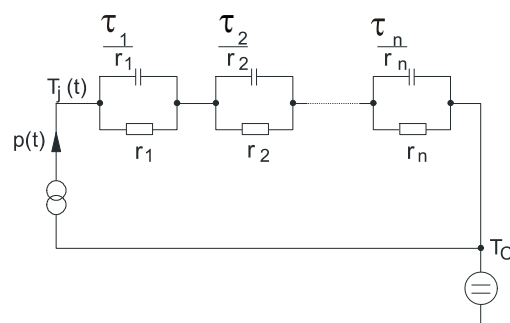


Figure D. Thermal equivalent circuit

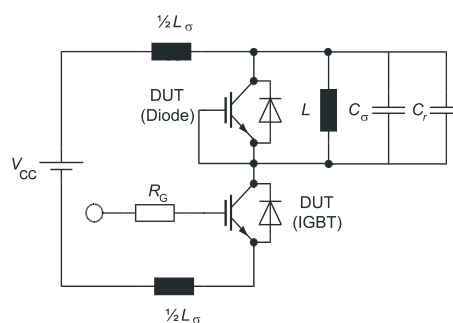


Figure E. **Dynamic test circuit**
 Parasitic inductance L_{σ} ,
 parasitic capacitor C_{σ} ,
 relief capacitor C_r ,
 (only for ZVT switching)

Revision history

Document revision	Date of release	Description of changes
1.00	2021-05-17	Final datasheet
1.10	2021-05-18	Update of diagram $E = f(T_{vj})$
1.20	2021-06-29	Update of diagram $E = f(T_{vj})$
1.30	2022-12-06	Update of “DC collector current, limited by T_{vjmax}” in table “Maximum rated values”, for 25°C and 100°C Transient gate-emitter voltage V_{GE} in table “Maximum rated values” of IGBT changed to $\pm 30V$ Update of diagram “Collector current as a function of case temperature”, $I_C = f(T_c)$ “Forward bias safe operating area” diagram renamed to “Reverse bias safe operating area” Correction of package outline dimensions Change package name to marketing name Editorial changes

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